## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Dong-Chul YOO	07/18/2006
Byoung-Jae BAE	07/18/2006
Jang-Eun HEO	07/18/2006
Ji-Eun LIM	07/19/2006
Dong-Hyun IM	07/19/2006

#### **RECEIVING PARTY DATA**

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City:	Gyeonggi-do	
State/Country:	KOREA, REPUBLIC OF	

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11464571

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Total Attachments: 2

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PATENT REEL: 018108 FRAME: 0359

PATENT APPLICATION Docket No.: 8750-187 Client Ref. No.: SPX200512-0011US

#### ASSIGNMENT

U.S.A. Patent Application Sole or Joint For Inventions Made Outside U.S.A. Executed With Application

In consideration of the sum of Ten Dollars (10.00) and other good and valuable considerations paid to each of the undersigned, to wit:

- (i) Dong-Chul YOO
- (2) Byoung-Jae BAE
- (3) Jang-Eun HEO
- (4) Ji-Eun LIM
- (5) Dong-Hyun IM

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the receipt and sufficiency of which are hereby acknowledged by the undersigned who hereby sell(s), assign(s) and transfer(s) unto:

SAMSUNG ELECTRONICS CO., LTD. 416 MAETAN-DONG, YEONGTONG-GU SUWON-SI, GYEONGGI-DO REPUBLIC OF KOREA

(hereinafter designated "ASSIGNEE") the entire right, title and interest in and to the invention as defined in 35 USC §100, for the United States of America, the invention entitled:

## HIGH-DENSITY PROBE ARRAY

for which an application for Letters Patent of the United States of America has been executed even date herewith by the undersigned, and in and to any and all divisionals, continuations, substitutes, and reissues thereof; and all resulting patents and the undersigned hereby authorizes and requests the United States Assistant Commissioner of Patents to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

And the undersigned hereby agrees to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE'S full protection and title in and to the invention hereby transferred.

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Please sign concurrently with Oath or Declaration and Power of Attorney

#### SIGNED ON THE DATES INDICATED BESIDE OUR SIGNATURES:

INVENTOR(S) DATE SIGNED (1) Ly Zh 00/18/2006

Dong-Chul YOO (2) <u>Byray-Thebal</u> 206. 9.18
Byoung-Jae BAE (3) <u>Reofielan</u> 2006.7.18

Jang-Eun HEO (4) L. f. f. f. 2006. 7.19

Ji-Eun LIM

(5) Dong Hyun IM 2006. 1.19.

#### PLEASE RETURN RECORDED ASSIGNMENT TO:

Alan T. McCollom Marger Johnson & McCollom 210 S.W. Morrison Street, Suite 400 Portland, OR 97204

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